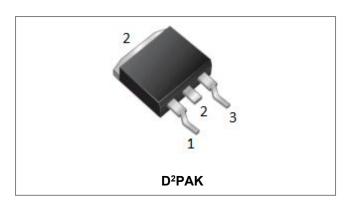


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MBRB20120CT SCHOTTKY RECTIFIER



Features

- 150°C T_J operation
- Center tap configuration
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Applications

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

O1 C

Circuit Diagram

Base common Cathode

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	-	120	V
Average Rectified Forward Current (Per Device)	lf (AV)	50% duty cycle @Tc=133°C, rectangular wave form	10(Per Leg) 20(Per Device)	A
Peak One Cycle Non-Repetitive Surge Current(Per Leg)	I _{FSM}	8.3ms, Half Sine pulse	150	А

Electrical Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop (Per Leg) *	V _{F1}	@ 10A, Pulse, T _J = 25 °C	0.84	0.90	V
	V _{F2}	@ 10A, Pulse, T _J = 125 °C	0.75	0.83	V
Reverse Current (Per Leg) *	I _{R1}	$@V_R = rated V_{R_i} T_J = 25 \ ^{\circ}C$	0.001	1.0	mA
	I _{R2}	$@V_R = rated V_{R,} T_J = 125 \ ^{\circ}C$	0.1	15	mA
Junction Capacitance(Per Leg)	Ст	$@V_R = 5V, T_C = 25 \ ^{\circ}C, f_{SIG} = 1MHz$	150	400	pF
Series Inductance(Per Leg)	Ls	Measured lead to lead 5 mm from package body	8.0	-	nH
Voltage Rate of Change	dv/dt	-	-	10,000	V/μs

* Pulse width < 300 µs, duty cycle < 2%

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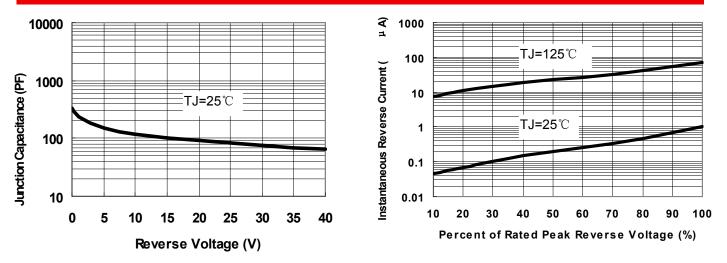
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RoHS 🗭

Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +150	°C
Storage Temperature	T _{stg}	-	-55 to +150	°C
Typical Thermal Resistance Junction to Case(Per Leg)	Rejc	DC operation	2.0	°C/W
Approximate Weight	wt	-	1.85	g
Case Style	D ² PAK			

Ratings and Characteristics Curves







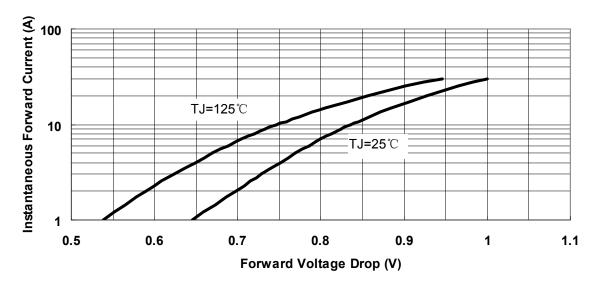


Fig.3-Typical Instantaneous Forward Voltage Characteristics

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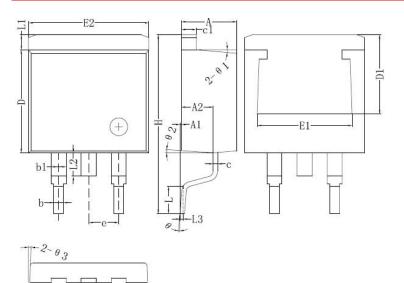


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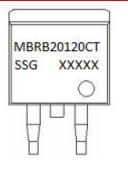


Mechanical Dimensions D²PAK



Symbol	Dimensions in millimeters			
	Min.	Typical	Max.	
Α	4.47	4.70	4.85	
A1	0	0.10	0.25	
A2	2.59	2.69	2.89	
b	0.71	0.81	0.96	
b1	1.17	1.27	1.37	
С	0.31	0.38	0.61	
c1	1.17	1.27	1.37	
D	8.50	8.70	8.90	
D1	6.40			
E	10.01	10.16	10.31	
E1	7.6			
E2	9.98	10.08	10.31	
е		2.54		
Н	14.6	15.1	15.6	
L	2.00	2.30	2.74	
L1	1.12	1.27	1.42	
L2	1.30		2.20	
L3		0.25BSC		
е	0	-	8°	
e1		5°		
e2		4°		
e3		4 °		

Marking Diagram



Where XXXXX is YYWWL

MBR

В

20

120

СТ

ΥY

L

ww

SSG

- = Device Type = Package type
- - = Forward Current (20A) = Reverse Voltage(120V)
 - = Configuration
 - = SSG
- = Year
- = Week
- = Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

Carrier Tape Specification D²PAK

Package

D²PAK

For information on tape and reel specifications, including part

orientation and tape sizes, please refer to our tape and reel

Shipping

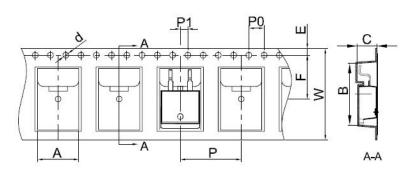
800pcs / reel

Ordering Information

Device

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packaging specification.



SYMBOL	Millimeters		
	Min.	Max.	
А	10.70	10.90	
В	16.03	16.23	
С	5.11	5.31	
d	1.45	1.65	
E	1.65	1.85	
F	11.40	11.60	
P0	3.90	4.10	
Р	15.90	16.10	
P1	1.90	2.10	
W	23.90	24.30	

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